

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hsien-Yu WU	02/10/2010
RECEIVING PARTY DATA	
Name:	Multi-Direction Co., Ltd.
Street Address:	5F., No. 67, Jung-Feng North Rd.,
City:	Chungli City, Taoyuan County
State/Country:	TAIWAN
Postal Code:	320
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12718949
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	P2380US
NAME OF SUBMITTER:	Chun-Ming Shih
Total Attachments: 1 source=ass380#page1.tif	

OP \$40.00 12718949

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PATENT
 REEL: 024039 FRAME: 0047

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Hsien-Yu WU
hereinafter referred to collectively as the assignor, has invented a certain improvement relating to
Headphone of Convenient Assembly and Package

☒ the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office;
☐ said application having been filed in the United States Patent and Trademark Office on _____
(Application Serial No. _____) the application serial number of said application when known;
☐ said application having been filed under the Patent Cooperation Treaty on _____
(Serial No. _____) the United States of America being designated.

AND WHEREAS MULTI-DIRECTION CO., LTD.

who's address is 5F., No.67, Jung-Feng North Rd., Chungli City, Taoyuan County 320, Taiwan

hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof.

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

<u>Wu, Hsien Yu</u>	<u>WU, Hsien Yu</u>	<u>February 10, 2010</u>
Name of sole or first inventor	Signature	Date

_____ Name of second inventor, if any	_____ Signature	_____ Date
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_____ Name of third inventor, if any	_____ Signature	_____ Date
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_____ Name of fourth inventor, if any	_____ Signature	_____ Date
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_____ Name of fifth inventor, if any	_____ Signature	_____ Date
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